Discription

The HESDNC712VB2I-C protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. Excellent clamping capability, low leakage, low capacitance, and fast response time provide best in class protection on designs that are exposed to ESD.

It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.

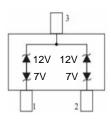


SOT-23

Features

- ★ Low capacitance.
- ★ Low clamping voltage.
- ★ ESD protection
- ★ Complies with IEC 61000-4-2 standards:Air discharge:±30 kV

 Contact discharge:±30k V
- ★ We declare that the material of product compliance with RoHS requirements and Halogen Free.



Circuit Diagram

Ordering Information

Product ID	Pack	Qty(PCS)
HESDNC712VB2I-C	SOT-23	3000

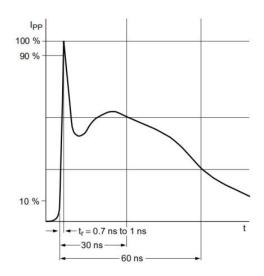
Absolute Ratings (T_{amb}=25°C)

Symbol	Parameter	Value	Units
P_{PP}	Peak Pulse Power (tp = 8/20µs)	300	W
T _L	Maximum lead temperature for soldering during 10s	260	ô
T _{stg}	Storage Temperature Range	-55 to +150	ů
T _{op}	Operating Temperature Range	-55 to +125	ô
T_j	Maximum junction temperature	150	ô
	IEC61000-4-2 (ESD) air discharge contact discharge	±30 ±30	KV
	IEC61000-4-4 (EFT)	15	Α

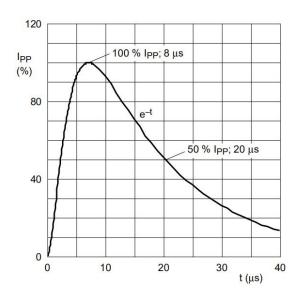
Electrical Characteristics Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Min	Тур	Max	Unit	Condition	
Reverse Working Voltage	V _{RWM}			7.0	V	Pin3 to Pin1 or 2	
				12.0		Pin1 or 2 to Pin3	
Breakdown Voltage	V_{BR}	7.5		9.5	V	I _T =1mA,Pin3 to Pin1 or 2	
		13.5		16.0		I _T =1mA,Pin1 or 2 to Pin3	
Leakage Current ILeak	I _R			0.1	μA	V _{RWM} =7V,Pin3 to Pin1 or 2	
				0.1		V _{RWM} =12V,Pin1 or 2 to Pin3	
Clamping Voltage	Vc		12.5	14.0	V	I _{PP} =18A,T _p =8/20μs,Pin3 to Pin1 or 2	
			18.5	20.0		I _{PP} =15A,T _p =8/20μs,Pin1 or 2 to Pin3	
Junction Capacitance	Сл		27.0	35.0	pF	V _R =0V, f=1MHz,Pin1 or 2 to Pin3	

Typical Characteristics



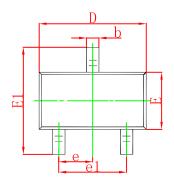
IEC61000-4-2 Waveform

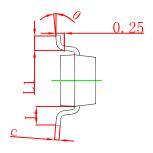


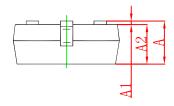
IEC 61000-4-5 Waveform(8/20µs pulse)



SOT-23 Package Outline Dimensions

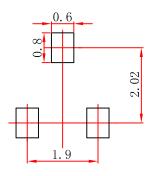






Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950	TYP	0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550) REF	0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

SOT-23 Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.

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